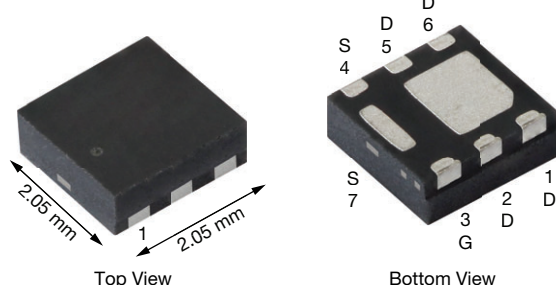


# Automotive P-Channel 60 V (D-S) 175 °C MOSFET

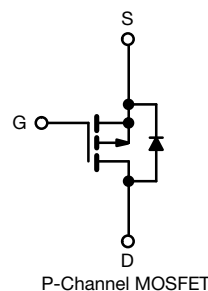
**PowerPAK® SC-70W-6L Single**

**Marking Code:** Q8XXXX

## PRODUCT SUMMARY

$V_{DS}$ (V)	-60
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -10$ V	0.1550
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -4.5$ V	0.2130
$I_D$ (A)	-6.46
Configuration	Single

## FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- Wettable flank terminals
- 100 %  $R_g$  and UIS tested
- Material categorization:  
for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**


## ORDERING INFORMATION

Package	PowerPAK SC-70W-6L
Lead (Pb)-free and halogen-free	SQA411CEJW (for detailed order number please see <a href="http://www.vishay.com/doc?79776">www.vishay.com/doc?79776</a> )

## ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-source voltage	$V_{DS}$	-60	V
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Continuous drain current	$I_D$	$T_C = 25$ °C	-6.46
		$T_C = 125$ °C	-3.73
Continuous source current (diode conduction) <sup>a</sup>	$I_S$	-9	A
Pulsed drain current <sup>b</sup>	$I_{DM}$	-20	A
Single pulse avalanche current	$I_{AS}$	-14	A
Single pulse avalanche energy	$E_{AS}$	9.8	mJ
Maximum power dissipation	$P_D$	$T_C = 25$ °C	13.6
		$T_C = 125$ °C	4.5
Operating junction and storage temperature range	$T_J, T_{stg}$	-55 to +175	°C
Soldering recommendations (peak temperature) <sup>d, e</sup>		260	°C

## THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-ambient	$R_{thJA}$	90	°C/W
Junction-to-case (drain)	$R_{thJC}$	11	°C/W

### Notes

- Package limited
- Pulse test; pulse width  $\leq 300$   $\mu$ s, duty cycle  $\leq 2$  %
- When mounted on 1" square PCB (FR4 material)
- See solder profile ([www.vishay.com/doc?73257](http://www.vishay.com/doc?73257)). The PowerPAK SC-70W-6L is a leadless package and features wettable flank terminals. The end of the lead terminal is plated with tin.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

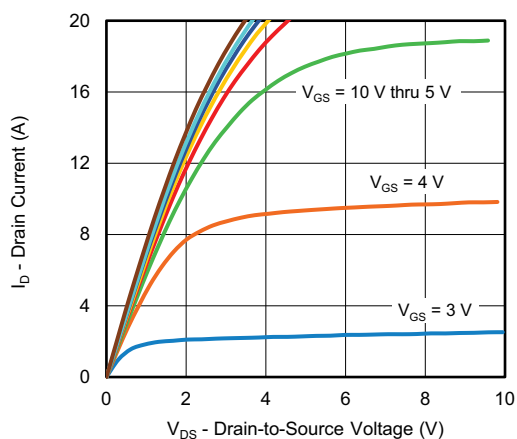
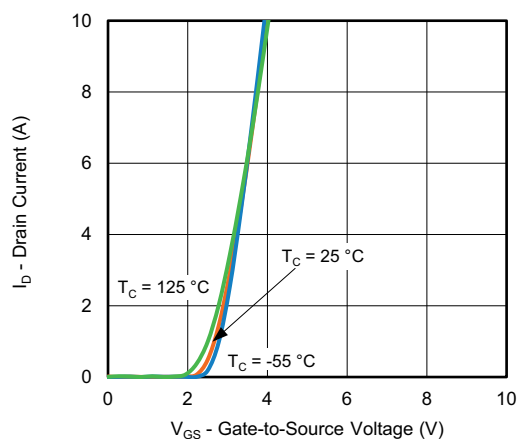
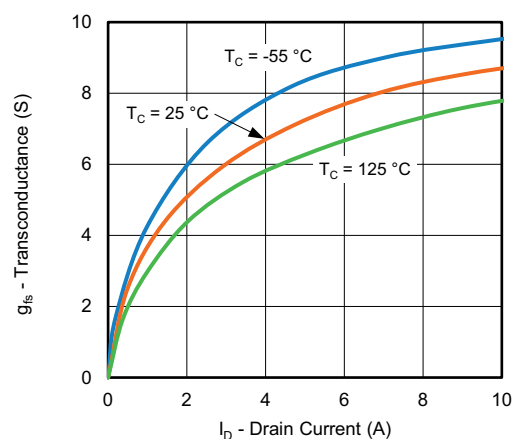
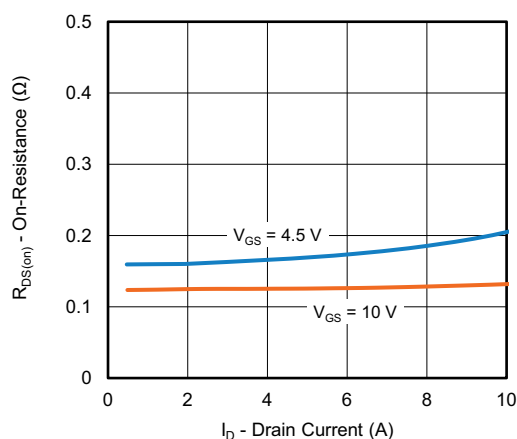
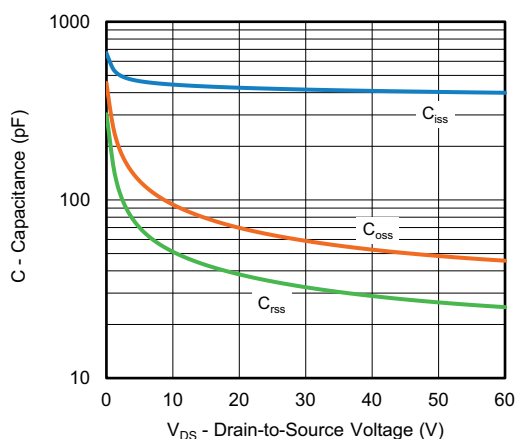
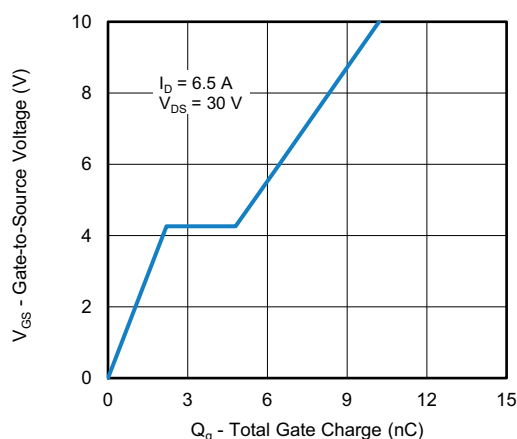


SPECIFICATIONS (T <sub>C</sub> = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA		-60	-	-	V
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA		-1.5	-2.0	-2.5	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -60 V	-	-	-1	μA
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -60 V, T <sub>J</sub> = 125 °C	-	-	-50	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -60 V, T <sub>J</sub> = 175 °C	-	-	-250	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = -10 V	V <sub>DS</sub> ≥ -5 V	-6	-	-	A
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -3.5 A	-	0.1255	0.1550	Ω
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -3.5 A, T <sub>J</sub> = 125 °C	-	-	0.2639	
		V <sub>GS</sub> = -10 V	I <sub>D</sub> = -3.5 A, T <sub>J</sub> = 175 °C	-	-	0.3261	
		V <sub>GS</sub> = -4.5 V	I <sub>D</sub> = -3 A	-	0.1645	0.2130	
Forward transconductance <sup>b</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -3.5 A		-	6	-	S
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = -25 V, f = 1 MHz	-	421	590	pF
Output capacitance	C <sub>oss</sub>			-	64	90	
Reverse transfer capacitance	C <sub>rss</sub>			-	35	50	
Total gate charge <sup>c</sup>	Q <sub>g</sub>	V <sub>GS</sub> = -10 V	V <sub>DS</sub> = -30 V, I <sub>D</sub> = -6.5 A	-	10.2	15.5	nC
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>			-	2.2	-	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	2.6	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz		2.50	5.18	7.80	Ω
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>	V <sub>DD</sub> = -30 V, R <sub>L</sub> = 12 Ω I <sub>D</sub> ≡ -2.5 A, V <sub>GEN</sub> = -10 V, R <sub>g</sub> = 1 Ω		-	7	12	ns
Rise time <sup>c</sup>	t <sub>r</sub>			-	4	7	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	17	29	
Fall time <sup>c</sup>	t <sub>f</sub>			-	4	7	
Source-Drain Diode Ratings and Characteristics <sup>b</sup>							
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	-20	A
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = -3.5 A, V <sub>GS</sub> = 0 V		-	-0.88	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = -2 A, di/dt = 100 A/μs		-	24	48	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	28	56	nC
Reverse recovery fall time	t <sub>a</sub>			-	21	-	ns
Reverse recovery rise time	t <sub>b</sub>			-	3	-	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-3.4	-	A

**Notes**

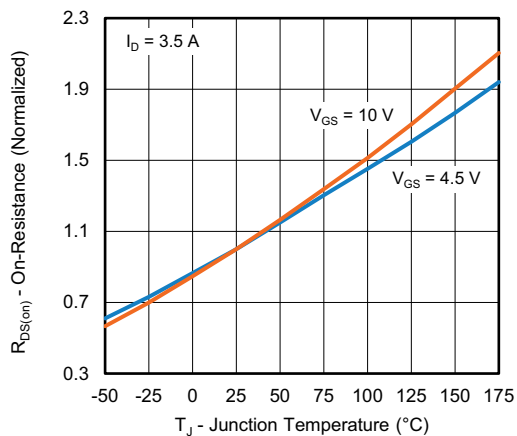
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$   
b. Guaranteed by design, not subject to production testing  
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

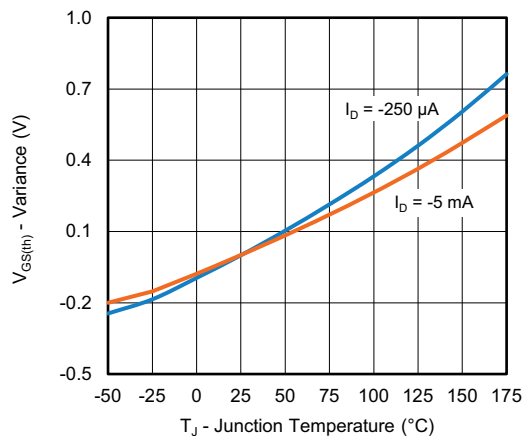
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**Output Characteristics**

**Transfer Characteristics**

**Transconductance**

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**



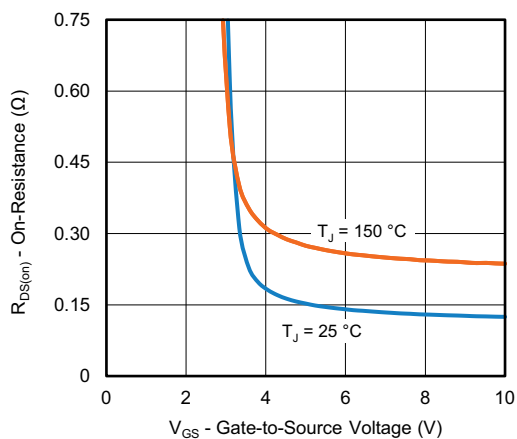
**TYPICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)



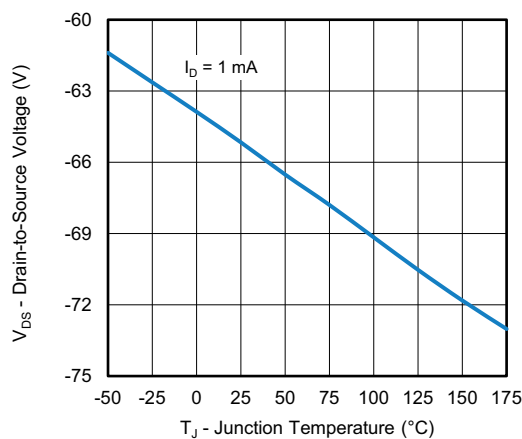
**On-Resistance vs. Junction Temperature**



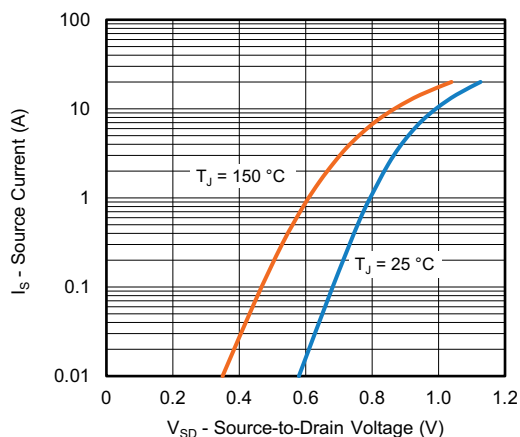
**Threshold Voltage**



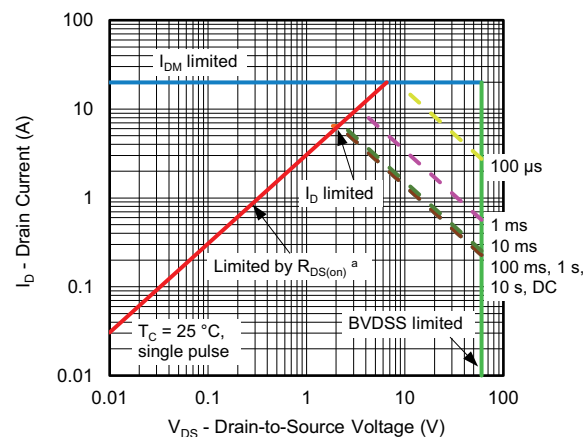
**On-Resistance vs. Gate-to-Source Voltage**



**Drain Source Breakdown vs. Junction Temperature**



**Source Drain Diode Forward Voltage**



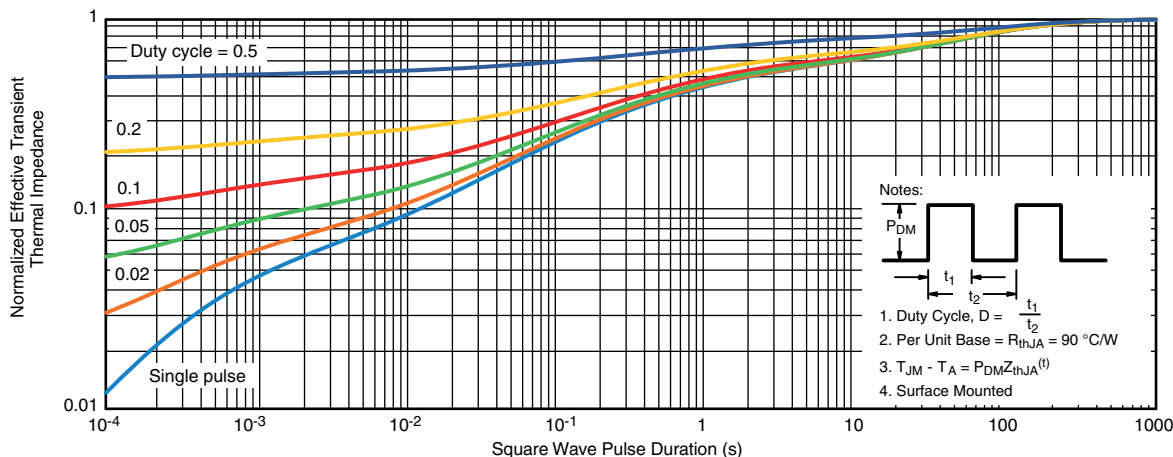
**Safe Operating Area**

**Note**

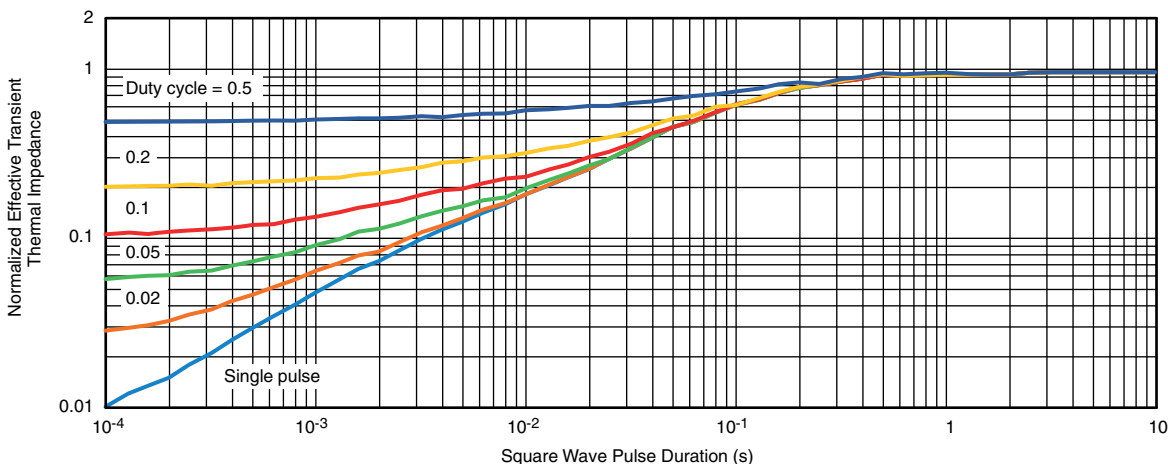
a.  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



**THERMAL RATINGS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Case**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?63171](http://www.vishay.com/ppg?63171).

## PowerPAK® SC70W-6L SIDEWETTABLE



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.70	0.80	0.90	0.027	0.031	0.035
A1	0.00	0.02	0.05	0.000	0.001	0.002
A2	0.10	-	-	0.004	-	-
b	0.25	0.30	0.35	0.010	0.012	0.014
b1	0.15	0.20	0.23	0.006	0.008	0.009
C	0.20	0.25	0.30	0.008	0.010	0.012
D	1.95	2.05	2.15	0.077	0.081	0.085
D1	0.88	0.98	1.08	0.035	0.039	0.043
D2	0.20	0.25	0.30	0.008	0.010	0.012
E	1.95	2.05	2.15	0.077	0.081	0.085
E1	1.06	1.16	1.26	0.042	0.046	0.050
E2	0.82	0.87	0.92	0.032	0.034	0.036
e	0.65 BSC			0.026 BSC		
e1	1.30 BSC			0.051 BSC		
K	0.20 typ.			0.008 typ.		
K1	0.47 typ.			0.019 typ.		
K2	0.23 typ.			0.009 typ.		
K3	0.18 typ.			0.007 typ.		
K4	0.35 typ.			0.014 typ.		
K5	0.35 typ.			0.014 typ.		
K6	0.38 typ.			0.015 typ.		
L	0.15	0.25	0.35	0.006	0.010	0.014
L1	-	0.10	-	-	0.004	-

ECN: C19-1644-Rev. A, 10-Jan-2020  
DWG: 6076

### Notes

- Package outline exclusive of mold flash and metal burr
- Package outline inclusive of plating



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.